



BC856AW - BC858CW

PNP SURFACE MOUNT SMALL SIGNAL TRANSISTOR

Features

Ideally Suited for Automatic Insertion

Complementary NPN Types Available (BC846W-BC848W)

For Switching and AF Amplifier Applications

Lead Free/RoHS Compliant (Note 3)

"Green" Device (Note 4 and 5)

Mechanical Data

Case: SOT-323

Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification

Rating 94V-0

Moisture Sensitivity: Level 1 per J-STD-020C

Terminals: Solderable per MIL-STD-202, Method 208

Lead Free Plating (Matte Tin Finish annealed over

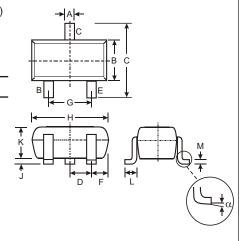
Alloy 42 leadframe).

Pin Connections: See Diagram

Marking Code: See Table Below & Diagram on Page 2

Ordering & Date Code Information: See Page 2

Weight: 0.006 grams (approximate)



SOT-323										
Dim	Dim Min Max									
Α	0.25	0.40								
В	1.15	1.35								
С	2.00	2.20								
D	0.65 N	ominal								
Е	0.30	0.40								
G	1.20	1.40								
Н	1.80	2.20								
J	0.0 0.10									
K	0.90	1.00								
L	0.25	0.40								
M	0.10	0.18								
	0	8								
All Din	nensions	in mm								

Marking Code (Note 2)										
Type Marking Type Marking										
BC856AW	КЗА	BC857CW	K3G							
BC856BW	КЗВ	BC858AW	K3J, K3A, K3V							
BC857AW	K3V, K3A	BC858BW	K3K, K3B, K3W							
BC857BW	K3W, K3B	BC858CW	K3L, K3G							

Maximum Ratings @ T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit
Collector-Base Voltage	Collector-Base Voltage BC856 BC857 BC858		-80 -50 -30	٧
Collector-Emitter Voltage	BC856 BC857 BC858	V _{CEO}	-65 -45 -30	V
Emitter-Base Voltage		V _{EBO}	-5.0	V
Collector Current		Ic	-100	mA
Peak Collector Current		I _{CM}	-200	mA
Peak Emitter Current		I _{EM}	-200	mA
Power Dissipation (Note 1)		P _d	200	mW
Thermal Resistance, Junction to Ambient (Not	e 1)	R JA	625	°C/W
Operating and Storage Temperature Range		T _j , T _{STG}	-65 to +150	°C

- Notes: 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
 - 2. Current gain subgroup "C" is not available for BC856W.
 - 3. No purposefully added lead.
 - 4. Diodes Inc.'s "Green" Policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
 - 5. Product manufactured with date code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to date code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.



Electrical Characteristics @ T_A =25°C unless otherwise specified

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage (Note 6)	V _{(BR)CBO}	-80 -50 -30	_ _ _	=	V	I _C = 10 A, I _B = 0	
Collector-Emitter Breakdown Voltage (Note 6)	V _{(BR)CEO}	-65 -45 -30	_ _ _	_	V	I _C = 10mA, I _B = 0	
Emitter-Base Breakdown Voltage (Note 6)		V _{(BR)EBO}	-5	_	_	V	$I_E = 1 A, I_C = 0$
DC Current Gain (Note 4) Current Gain (h _{FE}	125 220 420	180 290 520	250 475 800	_	V _{CE} = -5.0V, I _C = -2.0mA	
Collector-Emitter Saturation Voltage (Note 6)	V _{CE(SAT)}	_	-75 -250	-300 -650	mV	I _C = -10mA, I _B = -0.5mA I _C = -100mA, I _B = -5.0mA	
Base-Emitter Saturation Voltage (Note 6)	V _{BE(SAT)}		-700 -850	 -950	mV	I _C = -10mA, I _B = -0.5mA I _C = -100mA, I _B = -5.0mA	
Base-Emitter Voltage (Note 6)	V _{BE(ON)}	-600 —	-650 —	-750 -820	mV	V _{CE} = -5.0V, I _C = -2.0mA V _{CE} = -5.0V, I _C = -10mA	
Collector-Cutoff Current (Note 6)	I _{CBO}		_	-15 -4.0	nΑ μΑ	V _{CB} = -30V V _{CB} = -30V, T _A = 150°C	
Gain Bandwidth Product	f⊤	100	200	_	MHz	$V_{CE} = -5.0V$, $I_{C} = -10mA$, $f = 100MHz$	
Collector-Base Capacitance	C _{CBO}	_	3	4.5	pF	V _{CB} = -10V, f = 1.0MHz	
Noise Figure	NF		_	10	dB	$V_{CE} = -5.0V$, $I_C = 200\mu A$, $P_S = 2k$ $f = 1kHz$, $f = 200Hz$	

Ordering Information (Note 5 & 7)

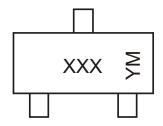
Device	Packaging	Shipping
BC85xxW-7-F	SOT-323	3000/Tape & Reel

^{*}xx = device type, e.g. BC856AW-7.

Notes: 5. Product manufactured with date code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to date code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

- 6. Short duration pulse test to minimize self-heating effect.
- 7. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



XXX = Product Type Marking Code (See Page 1), e.g. K3A = BC856AW

YM = Date Code Marking

Y = Year ex: N = 2002

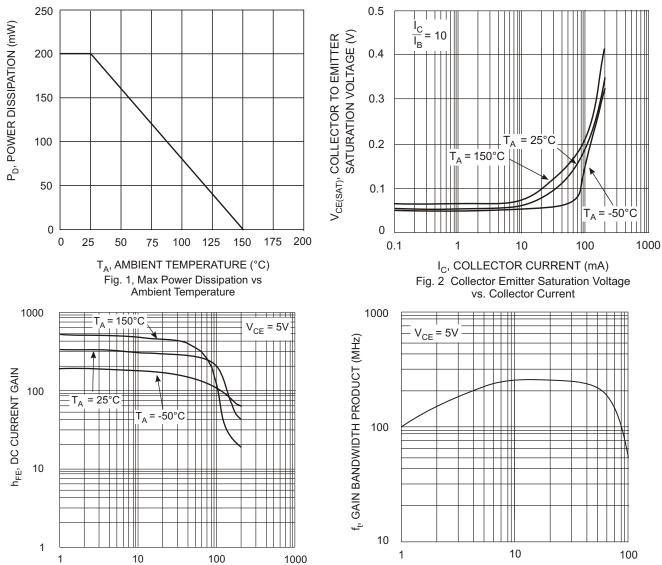
M = Month ex: 9 = September

Date Code Key

Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	J	K	L	М	N	Р	R	S	Т	U	V	W	Х	Υ	Z

Month	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D





 $\label{eq:lc} I_C, \text{COLLECTOR CURRENT (mA)}$ Fig. 3, DC Current Gain (Group B) vs. Collector Current

I_C, COLLECTOR CURRENT (mA)
Fig. 4, Gain Bandwidth Product vs Collector Current

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